

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT5039798

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHELESH CHOPRA	07/05/2018
KWANGYOUNG JUNG	07/03/2018
SCOTT RANDOLPH QUESNELLE	07/03/2018
BAN WANG	07/03/2018
SANJEEV KUMAR LOHCHAB	07/05/2018
SREELATHA POBBATHI	07/04/2018
RECEIVING PARTY DATA	
Name:	EMC IP HOLDING COMPANY LLC
Street Address:	176 SOUTH STREET
City:	HOPKINTON
State/Country:	MASSACHUSETTS
Postal Code:	01748
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16028711
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	paula.hardilek@chamberlainlaw.com
Correspondent Name:	PAULA HARDILEK
Address Line 1:	1200 SMITH ST., 14TH FLOOR
Address Line 4:	HOUSTON, TEXAS 77002
ATTORNEY DOCKET NUMBER:	170360-023500US
NAME OF SUBMITTER:	ALY Z. DOSSA
SIGNATURE:	/Aly Z. Dossa/
DATE SIGNED:	07/06/2018
Total Attachments: 8	
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ASSIGNMENT

WHEREAS, we, Shelesh Chopra, Kwangyoung Jung, Scott Randolph Quesnelle, Ban Wang, Sanjeev Kumar Lohchab, and Sreelatha Pobbathi, have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled SYSTEM AND METHOD FOR ORCHESTRATED APPLICATION PROTECTION, the specification of which:

☒ is being executed on even date herewith and is about to be filed in the United States Patent Office;

☐ was filed on _____ as U.S. Application No. _____;

☐ was patented under U.S. Patent No. _____ on _____.

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of the Commonwealth of Massachusetts and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution,

reissue, divisional or continuation applications and preliminary or other statements and the giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

Date:

5/7/2018



Inventor's Signature

Print full name of first inventor:

Shelesh CHOPRA

Residence:

Bangalore, India

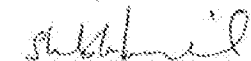
Citizenship:

India

Mailing Address:

c/o EMC IP Holding Company LLC
176 South Street
Hopkinton, MA 01748

I SHAMBHU PRASAD JAISWAL (name) whose residential address is - 1649, Mandarvada
Layout, Bakkara village, Bannerghatta road, Jigani, Bangalore - 560083
was personally present and did see SHELESH CHOPRA (name of person signing
the assignment) who is personally known to me, execute the above assignment.



(signature of first witness)

Signed at

Bangalore

(location of witness signature)

on this day 5/7/2018

of 20 18, (date of signature)

I Sanjeev K Lohchab (name) whose residential address is
#92, 3rd cross, South Avenue Layout, Gottiger, Bangalore -
was personally present and did see Shelesh Chopra (name of person signing 560083
the assignment) who is personally known to me, execute the above assignment.



(signature of second witness)

Signed at

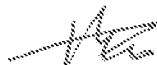
Bangalore

(location of witness signature)

on this day 5/7

of 20 18, (date of signature)

Date: July 3rd, 2018



Inventor's Signature

Print full name of second inventor: **Kwangyoung JUNG**
Residence: Mississauga, Canada
Citizenship: Canada
Mailing Address: c/o EMC IP Holding Company LLC
176 South Street
Hopkinton, MA 01748

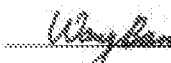
I SCOTT RANDOLPH OLESWELL (name) whose residential address is
844 MARLBY CRT BURLINGTON, ON L7T 3S5
was personally present and did see KWANGYOUNG JUNG (name of person signing
the assignment) who is personally known to me, execute the above assignment.

 (signature of first witness)

Signed at BURLINGTON, ON (location of witness signature)

on this day JULY 3RD of 2018. (date of signature)

I Bao WANG (name) whose residential address is
1484 Tyndale Park Dr, Burlington, ON, Canada
was personally present and did see Kwangyoung Jung (name of person signing
the assignment) who is personally known to me, execute the above assignment.

 (signature of second witness)

Signed at Burlington, ON, Canada (location of witness signature)

on this day July 3rd of 20 18. (date of signature)

Date: JULY 3RD 2018



Inventor's Signature

Print full name of third inventor:

Scott Randolph QUESNELLE

Residence:

Burlington, Canada

Citizenship:

Canada

Mailing Address:

c/o EMC IP Holding Company LLC
176 South Street
Hopkinton, MA 01748

I Kwangyoung Jung (name) whose residential address is
5255 palmetto place unit 134 Kitchissippi, ON, Canada L5M 0H2
was personally present and did see Scott Quesnelle (name of person signing
the assignment) who is personally known to me, execute the above assignment.

[Signature] (signature of first witness)

Signed at Burlington, Canada (location of witness signature)

on this day July 3rd of 2018 (date of signature)

I Ban WANG (name) whose residential address is
1404 Trandaya Park Dr. Burlington, ON, Canada
was personally present and did see Scott Quesnelle (name of person signing
the assignment) who is personally known to me, execute the above assignment.

[Signature] (signature of second witness)

Signed at Burlington, ON, Canada (location of witness signature)

on this day July 3rd of 2018 (date of signature)

Date: 2018-07-03

Waylan

Inventor's Signature

Print full name of fourth inventor:

Ban WANG

Residence:

Burlington, Canada

Citizenship:

China

Mailing Address:

c/o EMC IP Holding Company LLC
176 South Street
Hopkinton, MA 01748

I Kwangyoung Jung (name) whose residential address is
5255 palmetto pl unit 134, Mississauga, ON Canada L5M0H2
was personally present and did see Ban Wang (name of person signing
the assignment) who is personally known to me, execute the above assignment.

[Signature]

(signature of first witness)

Signed at Burlington, Canada (location of witness signature)

on this day July 3rd of 20 18. (date of signature)

I SLOTT RANDOLPH QUESNELLE (name) whose residential address is
844 MARLEY CRT BURLINGTON, ON L7T 3S5
was personally present and did see BAN WANG (name of person signing
the assignment) who is personally known to me, execute the above assignment.

[Signature]

(signature of second witness)

Signed at BURLINGTON ON (location of witness signature)

on this day JULY 3rd of 20 18. (date of signature)

Date: 5/7/2018

[Signature]
Inventor's Signature

Print full name of fifth inventor: **Sanjeev Kumar LOHCHAB**
Residence: Bangalore, India
Citizenship: India
Mailing Address: c/o EMC IP Holding Company LLC
176 South Street
Hopkinton, MA 01748

I SHAMBHU PRASAD JAISWAL (name) whose residential address is 1649, Nandan Varan Layout
Burkhanpura village, Banerghatta Post, Tigrani, Bangalore - 560083
was personally present and did see SHALESH CHOPRA (name of person signing
the assignment) who is personally known to me, execute the above assignment.

[Signature] (signature of first witness)

Signed at Bangalore (location of witness signature)

on this day 5/7/2018 of 20 18 (date of signature)

I Jayalagadda Ravindra (name) whose residential address is # building No 56, Ananda nilaya, 2nd cross, 1st Main, Kamadenu Nagar, B. Narayana puri
was personally present and did see Sanjeev Kumar LOHCHAB (name of person signing
the assignment) who is personally known to me, execute the above assignment. - 560016

[Signature] (signature of second witness)

Signed at Bangalore (location of witness signature)

on this day 5/7 of 20 18 (date of signature)

Date: 4-july-2018

P. Sreelatha
Inventor's Signature

Print full name of sixth inventor: **Sreelatha POBBATHI**
Residence: **Bangalore, India**
Citizenship: **India**
Mailing Address: **c/o EMC IP Holding Company LLC
176 South Street
Hopkinton, MA 01748**

I Sowmya D.N (name) whose residential address is
"SIMS Regency", Kalyan Nagar, Bangalore - 43
was personally present and did see Sreelatha P (name of person signing
the assignment) who is personally known to me, execute the above assignment.

[Signature] (signature of first witness)

Signed at Bangalore (location of witness signature)

on this day 4th July of 20 18 (date of signature)

I GIRISH CHANDRA BS (name) whose residential address is
HNO 1075, BRALAYOUT, ICNAGAR 8th PHASE, B'LORE 78
was personally present and did see [Signature] (name of person signing
the assignment) who is personally known to me, execute the above assignment.

[Signature] (signature of second witness)

Signed at BANGALORE (location of witness signature)

on this day 4TH JULY of 20 18 (date of signature)